

# 2SD1633

## Silicon NPN triple diffusion planar type darlington

For voltage switching

### ■ Features

- High-speed switching
- Satisfactory linearity of forward current transfer ratio  $h_{FE}$
- Full-pack package which can be installed to the heat sink with one screw

### ■ Absolute Maximum Ratings $T_C = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	$V_{CBO}$	100	V
Collector-emitter voltage (Base open)	$V_{CEO}$	100	V
Emitter-base voltage (Collector open)	$V_{EBO}$	7	V
Collector current	$I_C$	5	A
Peak collector current	$I_{CP}$	8	A
Base current	$I_B$	0.5	A
Collector power dissipation	$P_C$	30	W
		$T_a = 25^\circ\text{C}$	
Junction temperature	$T_j$	150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 to +150	$^\circ\text{C}$

### ■ Electrical Characteristics $T_C = 25^\circ\text{C} \pm 3^\circ\text{C}$

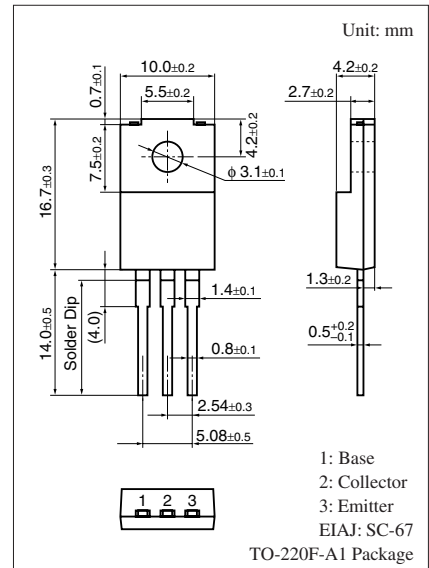
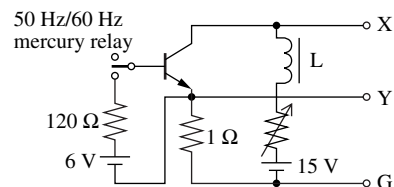
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-emitter sustaining voltage *2	$V_{CEO(SUS)}$	$I_C = 0.2 \text{ A}$ , $L = 25 \text{ mH}$	100			V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = 100 \text{ V}$ , $I_E = 0$			100	$\mu\text{A}$
Collector-emitter cut-off current (Base open)	$I_{CEO}$	$V_{CE} = 100 \text{ V}$ , $I_B = 0$			100	$\mu\text{A}$
Emitter-base cutoff current (Collector open)	$I_{EBO}$	$V_{EB} = 7 \text{ V}$ , $I_C = 0$			5	mA
Forward current transfer ratio *1	$h_{FE}$	$V_{CE} = 3 \text{ V}$ , $I_C = 3 \text{ A}$	1500		15000	—
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C = 3 \text{ A}$ , $I_B = 3 \text{ mA}$			1.5	V
Base-emitter saturation voltage	$V_{BE(sat)}$	$I_C = 3 \text{ A}$ , $I_B = 3 \text{ mA}$			2.0	V
Transition frequency	$f_T$	$V_{CE} = 10 \text{ V}$ , $I_C = 1 \text{ A}$ , $f = 1 \text{ MHz}$		15		MHz
Turn-on time	$t_{on}$	$I_C = 3 \text{ A}$ , $I_{B1} = 3 \text{ mA}$ , $I_{B2} = -3 \text{ mA}$			3	$\mu\text{s}$
Storage time	$t_{stg}$	$V_{CC} = 50 \text{ V}$			5	$\mu\text{s}$
Fall time	$t_f$				3	$\mu\text{s}$

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

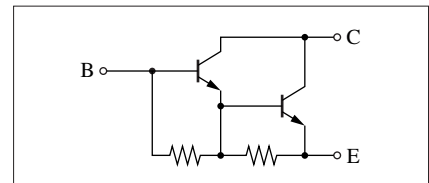
2. \*1: Rank classification

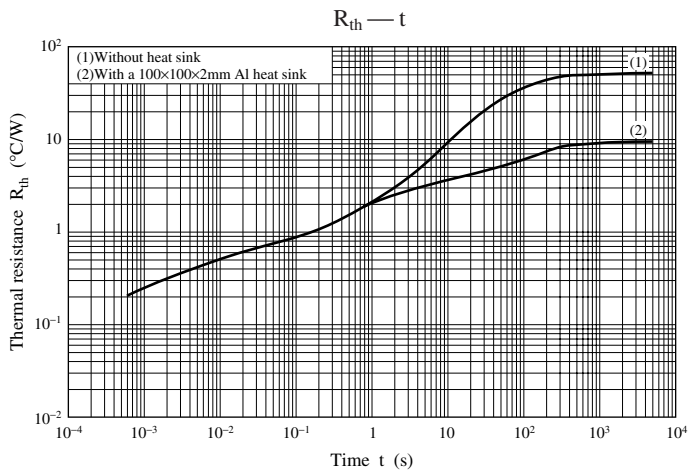
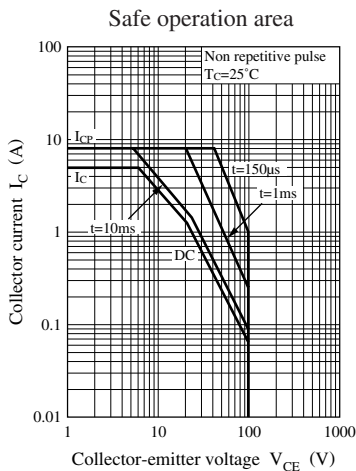
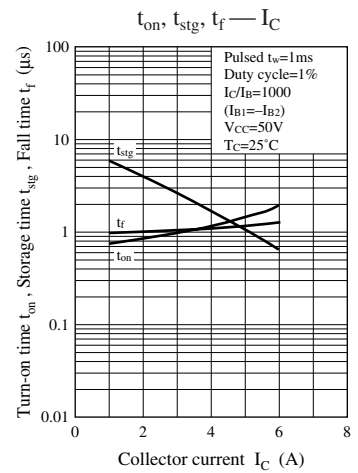
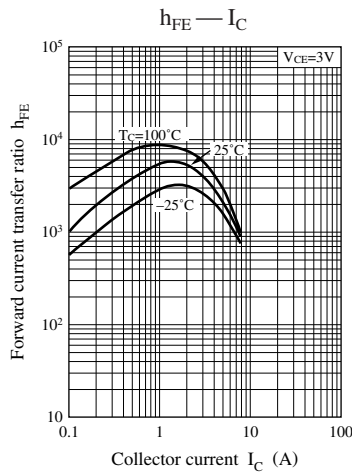
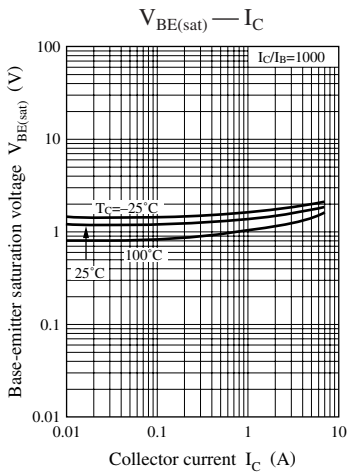
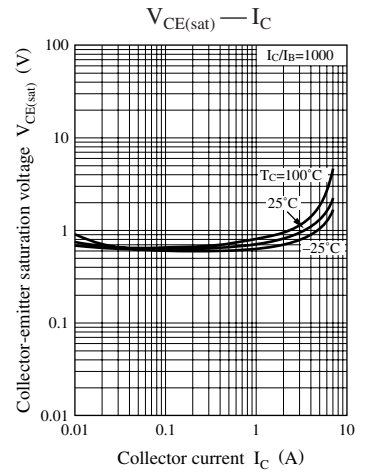
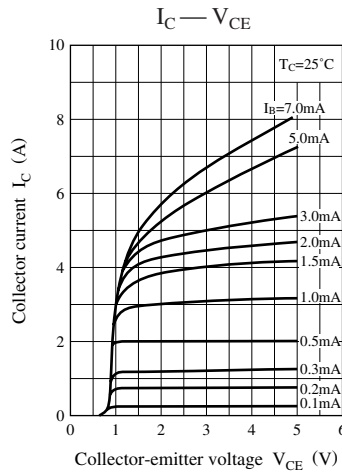
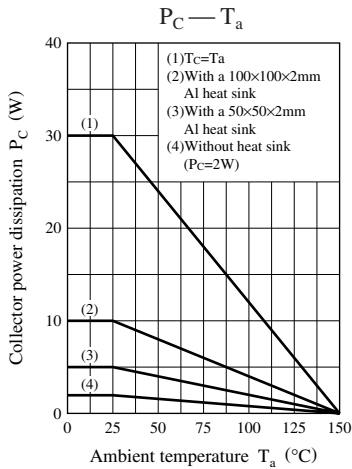
Rank	Q	P
$h_{FE}$	1500 to 6000	5000 to 15000

\*2:  $V_{CEO(SUS)}$  test circuit



### Internal Connection





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